IPC Acce

CoreModule® 800

Celeron® M PCI-104 Single Board Computer Ultra-High Performance



Features

- Gigabit Ethernet
- High Performance Video
- 2 RS-232/422/485 Serial ports
- 2 USB 2.0 ports
- PC/104 without wings
- HALT report available



Choose the Ampro by ADLINK™ CoreModule® 800 for...

Extreme Rugged™ embedded applications that need ultrahigh performance in a compact module that does not violate PC/104 outline specifications. Contact Ampro by ADLINK™ for HALT report.

Description

The Ampro by ADLINK™ CoreModule® 800 PCI-104 compatible SBC offers ultra low power Centrino performance with advanced networking, high-performance graphics and all the requisite PC-compatible component subsystems.

Specifications

Core System

CPU - 1.0GHz ULV Celeron® M 373

Cache - 512KB or 0KB Level 2

DRAM - Up to 1GB PC2700 DDR333 SODIMM

Chipset - Intel® 855GME/ICH4M

FSB – 400MHz

System Controllers - PC-compatible DMA and interrupt controllers and timers

Real Time Clock - Battery-backed RTC/CMOS

Watchdog timer

Powerfail Reset - Triggers when input voltage drops below predetermined thresholds

Bus Interface

PCI/104 (PCI), downward-stacking

PC/104 to PC/104-Plus bridge through optional MiniModule™ ISA card

I/O

PATA - Single Ultra DMA 33/66/100 IDE interface, supports up to two hard drives

Serial - 2 ports, RS-232/422/485

Parallel - EPP/ECP bidirectional port

Floppy – Supports 1 or 2 drives, shared with parallel

USB - 2 USB 2.0 ports (two root hubs)

Keyboard/Mouse - PS/2 interface

Network Interface

Ethernet - Intel® 82541 (1000BaseT) Ethernet

Video Interface

Controller – Integrated Intel® Extreme Graphics 2-AGP 4X 128-bit 3D engine

- Supports resolutions to 2048x1536
- Up to 64MB UMA Frame Buffer
- Dual channel LVDS
- Supports 3.3V or 5V flat panels

Software & Development Tools

OS Support – Ampro by ADLINKTM Embedded Linux®, VxWorks® v5.5.1, QNX® v6.3, Windows® CE 5.0, XP, XPe

BIOS – AMI

Mechanical

Size – 90x96mm (3.6x3.8"); PCI-104 form factor

Power Requirements – (with 512MB RAM, 100% CPU load) –2.8A @5V

Temperature (100 LFM system air flow)

- Standard: -20° to +70°C
- Extended: -40° to +85°C
- Storage: -55° to +85°C

(See manual for thermal operating requirements)

Board Thickness - .120" (3.05mm)

Ordering Information

Model Number	Description/Configuration
CM3-800-R-10	CoreModule® 800, 1GHz ULV Celeron® M CPU, 512KB L2 cache, PC/104, Ethernet, 2 COM
CM3-800-L-10	1GHz 512KB Cache QuickStart Kit (R-10 SBC, 512MB RAM, cable kit, software, documentation)
MM3-ISA-R-11	MiniModule ISA: PCI-104 to PC/104-Plus Bridge